## SDC2040C THRU SDC2045C

# Photovoltaic Solar Cell Protection Schottky Diode

Reverse Voltage - 40 to 45Volts Forward Current - 20.0 Amperes

#### **Features**

- Low power loss, high efficiency
- High current capability, low V<sub>F</sub>
- High surge capacity
- Meets UL flammability classification 94V-0

#### **Mechanical Data**

Case: TO-220AC molded plasticPolarity:As marked on body

Mounting position: Any

#### **Applications**

• For use in solar cell junction box as a bypass diode

#### **TO-220AC** 189 (4.8) .135 (3.44) .413 (10.5) 153 (3.9) .173 (4.4) RoHS .103 (2.62) 146 (3.7) COMPLIAN .270 (6.9) 230 (5.8 .610 <u>(15.5</u>) .583 (14.8) .04 Max. (1.0).583 (14.8) .057 (1.45) .045 (1.14) (4.5).043 (1.1) 032 (0.8) .024 (0.6) 102 (2.6) .012 (0.3) .091 (2.3)

Package Outline Dimensions in Inches (Millimeters)

### **Maximum Ratings and Electrical Characteristics**

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristics	Symbol	SDC2040C	SDC2045C	Unit
Maximum Repetitive Peak Reverse Voltage	VRRM	40	45	V
Maximum RMS Voltage	VRMS	28	31.5	V
Maximum DC Blocking Voltage	VDC	40	45	V
Maximum Average Forward Rectified Current @Tc=95 $^{\circ}$ C	I(AV)	20		Α
Peak Forward Surge Current, 8.3mS Single Half Sine-Wave,	Ігѕм	150		А
Superimposed on Rated Load (JEDEC Method)				
Peak Forward Voltage at 10A DC Per Chip (Note1)	VF	0.55		V
Maximum DC Reverse Current @TJ=25℃	lr	0	0.5	
at Rated DC Bolcking Voltage @TJ=125℃	IK	50		mA
Typical Thermal Resistance Junction to Case (Without Heatsink)	Rejc	1.5		°C/W
Junction Temperature Range	TJ	-55 to+200		${\mathbb C}$
Storage Temperature Range	Тѕтс	-55 to	-55 to+200	
Storage Temperature Kange	1816	-55 (0+200		,

Notes: 1. 300uS pulse width, 2%duty cycle.

2. The typical data above is for reference only .

SDC20\*C-U-00-00

Rev. 11, 18-May-2020



Fig. 1 - Forward Current Derating Curve

20
16
18
4
0
0
50
100
150
200

Case Temperature (°C)

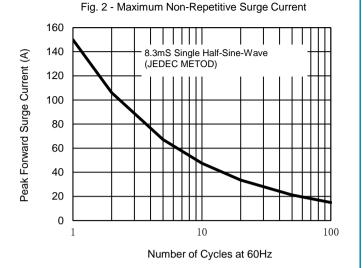


Fig. 3 - Typical Reverse Characteristics

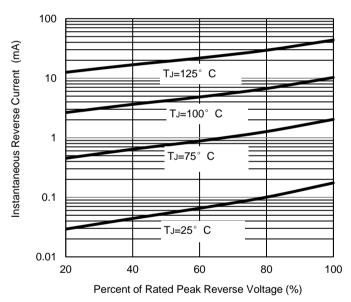
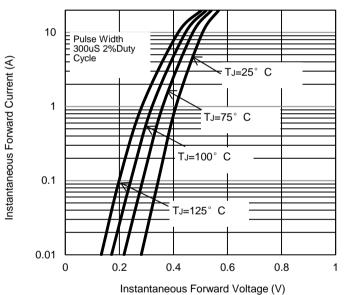


Fig. 4 - Typical Forward Characteristics





#### **Disclaimer**

ALL specifications and data are subject to be changed without notice to improve reliability function or design or other reasons.

HY makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the cotinuing production of any product. To the maximum extent permitted by applicable law, HY disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on HY's knowledge of typical requirements that are often placed on HY products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify HY's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, HY products are not designed for use in medical, life-saving, or life-sustaining applications or for any other applications in which the failure of the HY product could result in personal injury or death. Customers using or selling HY products not expressly indicated for use in such applications do so at their own risk. Please contact authorized HY personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of HY. Product names and markings noted herein may be trademarks of their respective owners.